

IN THE ABSTRACT

Please replace the Abstract at page 14 with the following new Abstract.

A transmission line element is formed in an integrated circuit chip. The transmission line element includes a plurality of parallel conductors, with each conductor including a plurality of electrically connected transmission lines. At least two of the transmission lines of each conductor are in different ones of plural metal layers of the integrated circuit chip. The metal layers are separated by at least one dielectric layer. Each transmission line in each conductor is edge-coupled to a transmission line of another of the conductors, and broadside-coupled to a transmission line of another of the conductors. The transmission line element can be used, for example, to fabricate various types of balanced and unbalanced transformers.